STS10PF30L

P-CHANNEL 30V - 0.012 Ω - 10A SO-8
STripFET™ II POWER MOSFET

Table 1: General Features

TYPE	V_{DSS}	$R_{DS(on)}$	I_D
STS10PF30L	30V	<0.014 Ω	10 A

- TYPICAL R_{DS}(on) = 0.012 Ω
- STANDARDOUTLINEFOR EASY AUTOMATED SURFACE MOUNT ASSEMBLY
- LOW THRESHOLD DRIVE

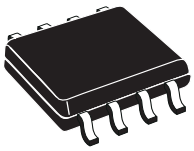
DESCRIPTION

This Power MOSFET is the latest development of STMicroelectronis unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance.

APPLICATIONS

- BATTERY MANAGEMENT IN NOMADIC EQUIPMENT
- LOAD SWITCH

Figure 1:Package



SO-8

Figure 2: Internal Schematic Diagram

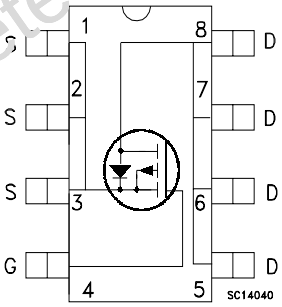


Table 2: Order Codes

SALES TYPE	MARKING	PACKAGE	PACKAGING
STS10PF30L	S10PF30L	SO-8	TAPE & REEL

Table 3: ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source Voltage (V_{GS} = 0)	30	V
V_{DGR}	Drain-gate Voltage (R_{GS} = 20 kΩ)	30	V
V_{GS}	Gate- source Voltage	± 16	V
I_D	Drain Current (continuous) at T_C = 25°C	10	A
I_D	Drain Current (continuous) at T_C = 100°C	6	A
I_{DM}(•)	Drain Current (pulsed)	40	A
P_{tot}	Total Dissipation at T_C = 25°C	2.5	W

Note: For the P-CHANNEL MOSFET actual polarity of voltages and current has to be reversed

Obsolete Product(s) - Obsolete Product(s)

Table 4: THERMAL DATA

Rthj-amb	(*) Thermal Resistance Junction-ambient	Max	47	°C/W
Rthj-lead	Thermal Resistance Junction-leads	Max	16	°C/W
T_l	Maximum Lead Temperature For Soldering Purpose	Typ	150	°C
T_{stg}	storage temperature		-55 to 150	°C

(*) When Mounted on 1 inch² FR-4 board, 2 oz of Cu and t ≤ 10 sec.

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

Table 5: OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source Breakdown Voltage	I_D = 250 µA, V_{GS} = 0	30			V
I_{DSS}	Zero Gate Voltage Drain Current (V_{GS} = 0)	V_{DS} = Max Rating V_{DS} = Max Rating T_C = 125°C			1 10	µA µA
I_{GSS}	Gate-body Leakage Current (V_{DS} = 0)	V_{GS} = ± 16 V			±100	nA

Table 6: ON (*)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS} I_D = 250 µA	1			V
$R_{DS(on)}$	Static Drain-source On Resistance	V_{GS} = 10 V I_D = 5 A V_{GS} = 4.5 V I_D = 5 A		0.012 0.015	0.014 0.018	Ω Ω

Table 7: DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g_{fs}	Forward Transconductance	V_{DS} = 10 V I_D = 5 A		31		S
C_{iss} C_{oss} C_{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V_{DS} = 25V, f = 1 MHz, V_{GS} = 0		2300 750 115		pF pF pF

Obsolete Product(s) - Obsolete Product(s)

ELECTRICAL CHARACTERISTICS (continued)

Table 8: SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$ t_r	Turn-on Delay Time Rise Time	V_{DD} = 15 V I_D = 5 A R_G = 4.7 Ω V_{GS} = 4.5 V (Resistive Load, Figure 15)		72 87		ns ns
Q_g Q_{gs} Q_{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	V_{DD}= 15V I_D= 10A V_{GS}=4.5V (see test circuit, Figure 16)		29 6.8 7.6	39	nC nC nC

Table 9: SWITCHING OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(off)}$ t_f	Turn-off Delay Time Fall Time	V_{DD} = 15 V I_D = 5 A R_G = 4.7Ω, V_{GS} = 4.5 V (Resistive Load, Figure 15)		89 27		ns ns

Table 10: SOURCE DRAIN DIODE

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{SD} I_{SDM}	Source-drain Current Source-drain Current (pulsed)				10 40	A A
V_{SD} (*)	Forward On Voltage	I_{SD} = 10 A V_{GS} = 0			1.2	V
t_{rr} Q_{rr} I_{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	I_{SD} = 10 A di/dt = 100A/µs V_{DD} = 15 V T_j = 150°C (see test circuit, Figure 17)		48.5 68 2.8		ns nC A

(*) Pulse width ≤ 300 µs, duty cycle 1.5 %.
(•) Pulse width limited by T_{JMAX}

Obsolete Product(s) - Obsolete Product(s)

Figure 3: Safe Operating Area

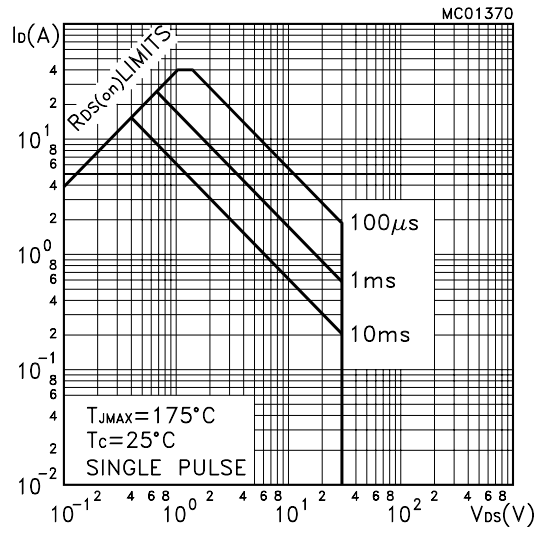


Figure 4: Thermal Impedance

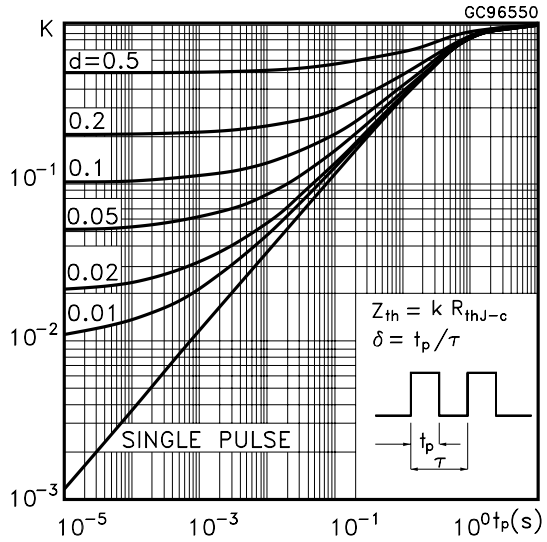


Figure 5: Output Characteristics

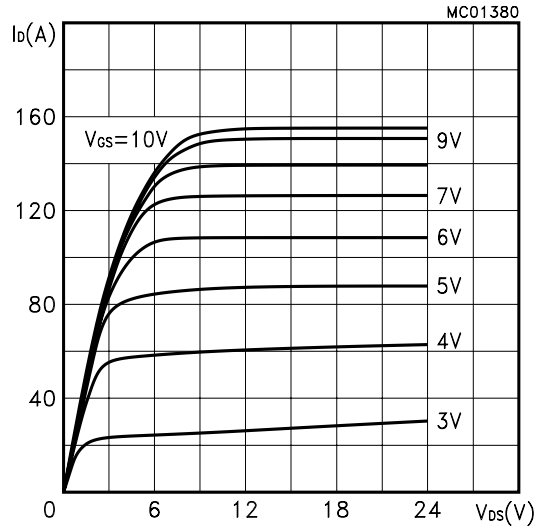


Figure 6: Transfer Characteristics

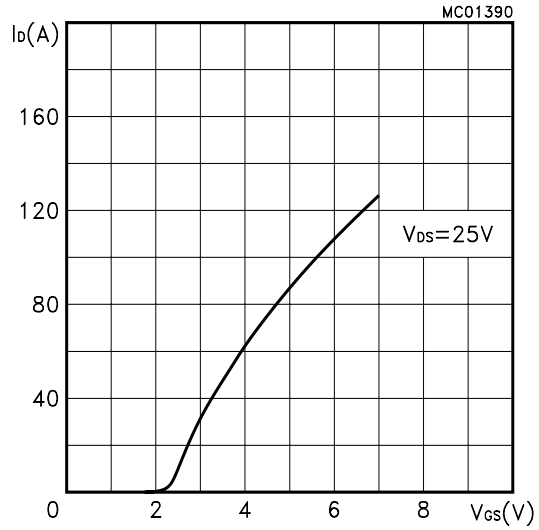


Figure 7: Transconductance

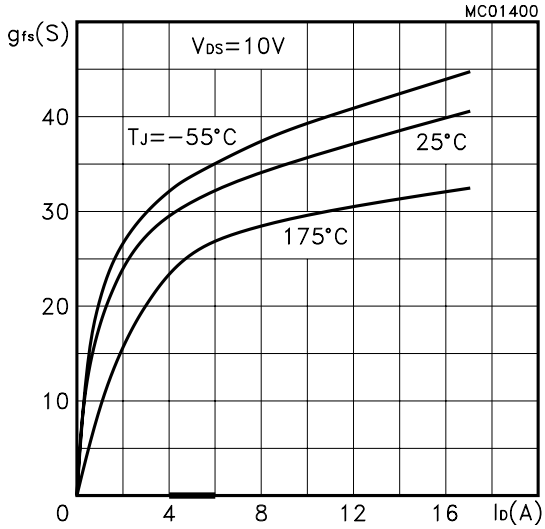


Figure 8: Static Drain-source On Resistance

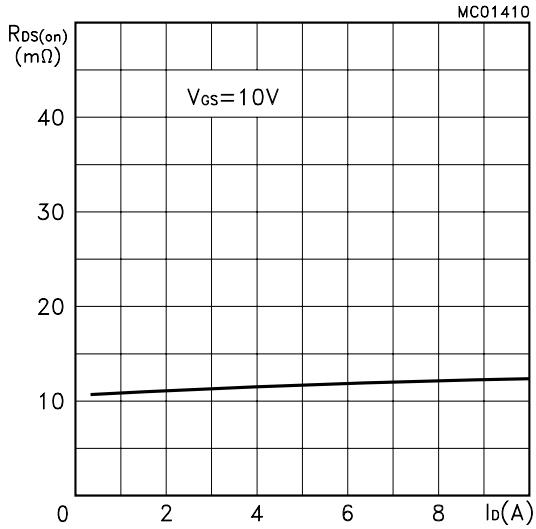


Figure 9: Gate Charge vs Gate-source Voltage

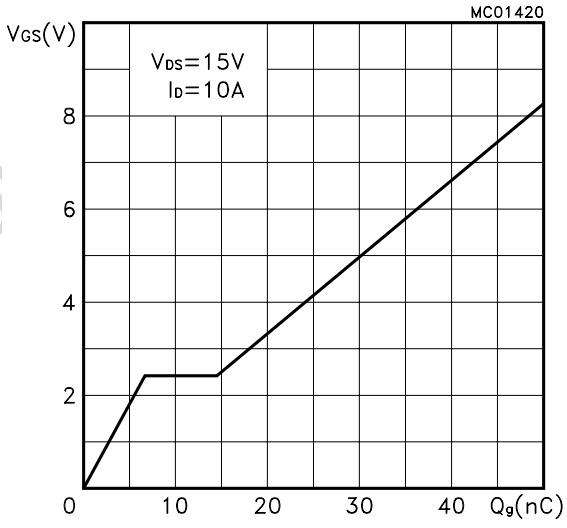


Figure 10: Capacitance Variations

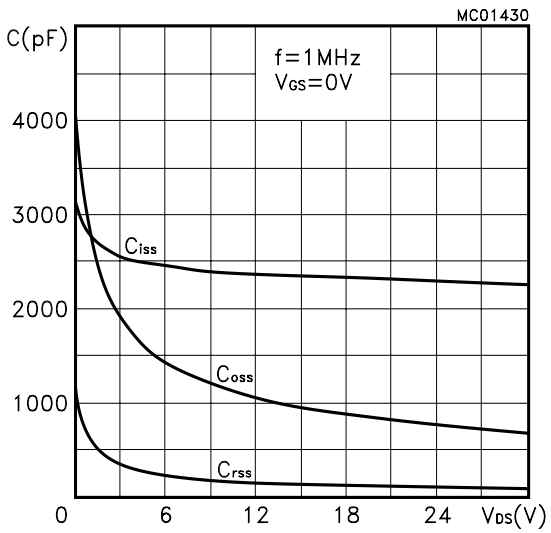


Figure 11: Normalized Gate Threshold Voltage vs Temperature

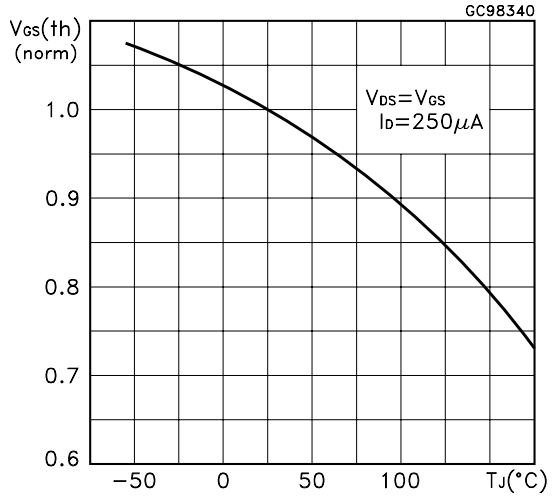


Figure 12: Normalized on Resistance vs Temperature

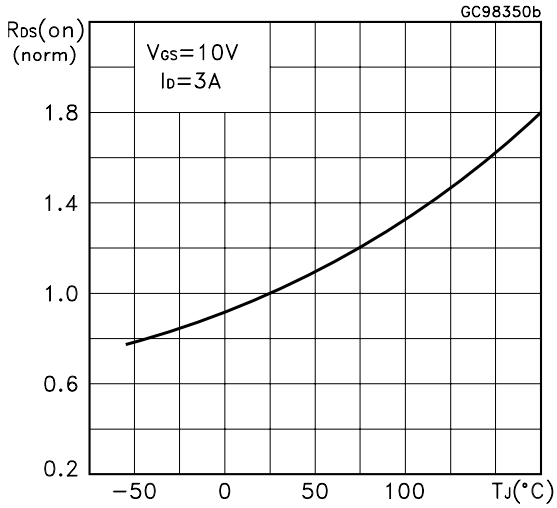


Figure 13: Source-drain Diode Forward Characteristics

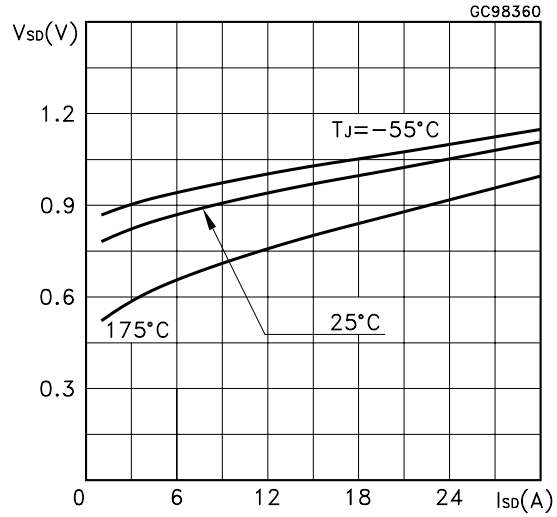


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Figure 14: Normalized Breakdown Voltage vs Temperature.

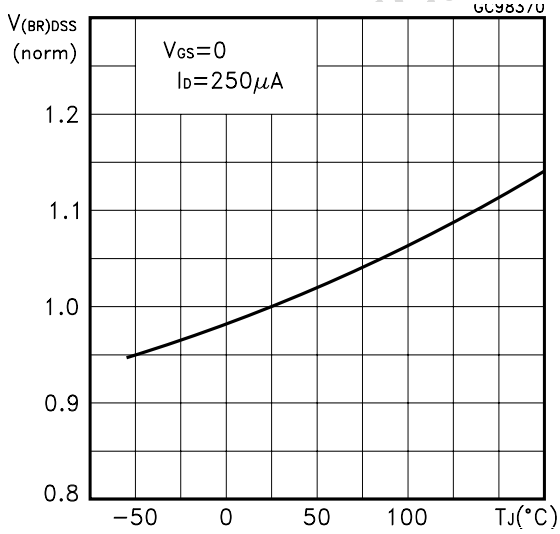

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Fig. 15: Switching Times Test Circuits For Resistive Load

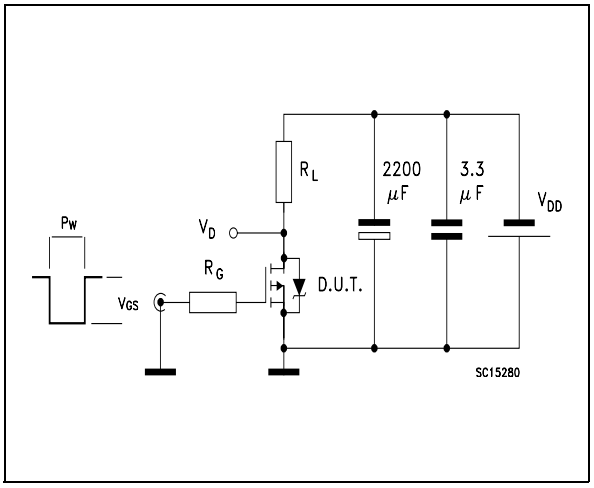


Fig. 16: Gate Charge test Circuit

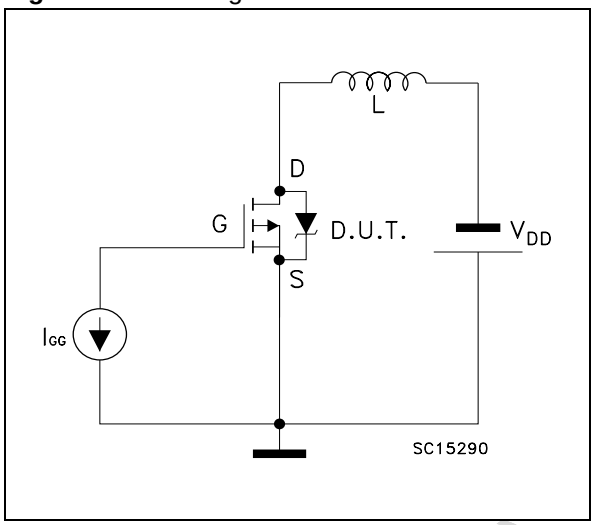
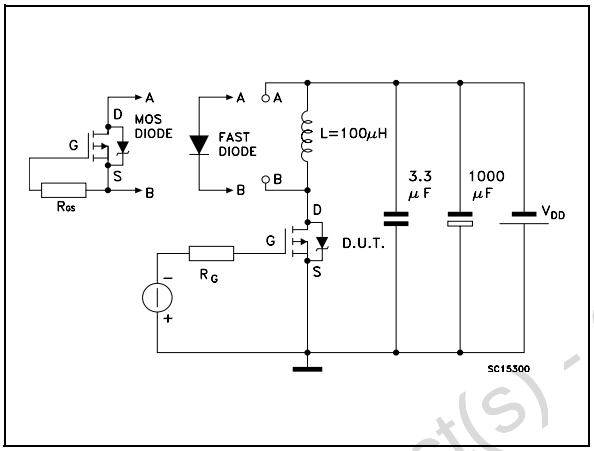


Fig. 17: Test Circuit For Diode Recovery Behaviour



Obsolete Product(s) - Obsolete Product(s)

SO-8 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.019
c1	45 (typ.)					
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
M			0.6			0.023
S	8 (max.)					

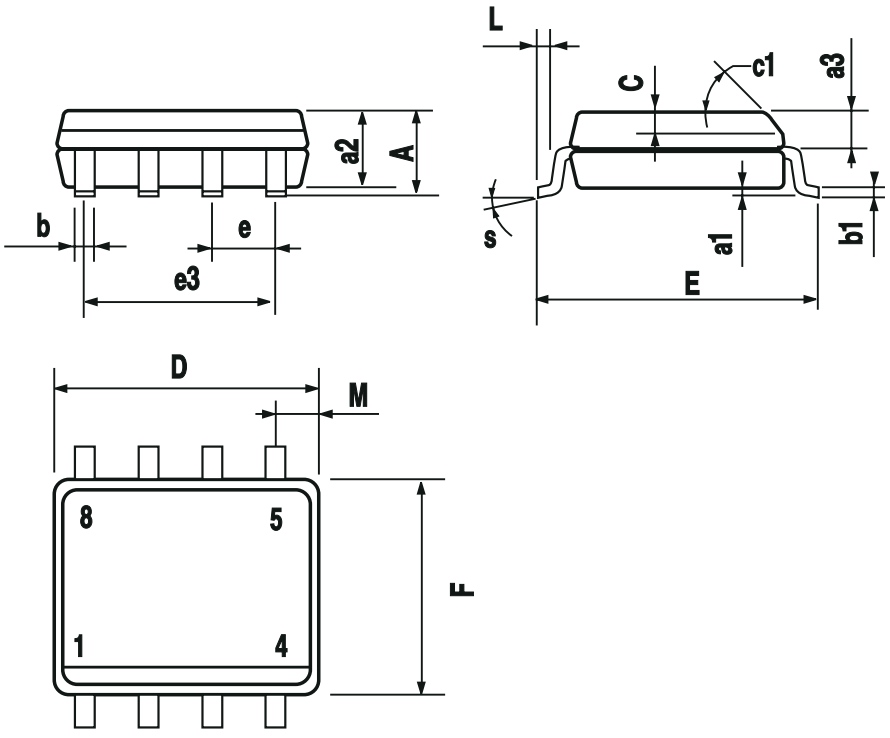


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Table 11:Revision History

Date	Revision	Description of Changes
May 2005	2.0	completed whit curves

Obsolete Product(s) - Obsolete Product(s)

Obsolete Product(s) - Obsolete Product(s)

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